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CONFIRMATION NO. 4022

<b>SERIAL NUMBER</b> 10/725,552	<b>FILING OR 371(c) DATE</b> 12/03/2003 <b>RULE</b>	<b>CLASS</b> 205	<b>GROUP ART UNIT</b> 1753	<b>ATTORNEY DOCKET NO.</b> MR1683-515
<b>APPLICANTS</b> Don-Gey Liu, Taichung, TAIWAN; Tsong-Jen Yang, Taichung, TAIWAN; Chin-Hao Yang, Taipei City, TAIWAN; Hong-Yuan Hsu, Daan Hsiang, TAIWAN; Wen Luh Yang, Chingshuei Jen, TAIWAN; Giin-Shan Chen, Taichung City, TAIWAN;				
<b>** CONTINUING DATA *****</b> <i>None</i>				
<b>** FOREIGN APPLICATIONS *****</b> TAIWAN 91134994 12/03/2002				
<b>IF REQUIRED, FOREIGN FILING LICENSE GRANTED **</b> 04/24/2004				
Foreign Priority claimed <input checked="" type="checkbox"/> yes <input type="checkbox"/> no 35 USC 119 (a-d) conditions met <input checked="" type="checkbox"/> yes <input type="checkbox"/> no <input checked="" type="checkbox"/> Met after Allowance Verified and Acknowledged <i>[Signature]</i> Examiner's Signature Initials	<b>STATE OR COUNTRY</b> TAIWAN	<b>SHEETS DRAWING</b> 5	<b>TOTAL CLAIMS</b> 8	<b>INDEPENDENT CLAIMS</b> 1
<b>ADDRESS</b> 04586				
<b>TITLE</b> Molding technique for copper interconnecting wires by electrochemical displacement deposition on the pre-shaped metal layer				
<b>FILING FEE RECEIVED</b> 900	FEES: Authority has been given in Paper No. _____ to charge/credit DEPOSIT ACCOUNT No. _____ for following:		<input type="checkbox"/> All Fees <input type="checkbox"/> 1.16 Fees ( Filing ) <input type="checkbox"/> 1.17 Fees ( Processing Ext. of time ) <input type="checkbox"/> 1.18 Fees ( Issue ) <input type="checkbox"/> Other _____ <input type="checkbox"/> Credit	